Editorial for Journal of Packaging Technology and Research

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The Journal of Packaging Technology and Research (JPAC) is an international peer-reviewed publication that publishes original, high quality research papers on topics related to packaging Science and Technology. The first issue (Volume 1, Number 1) of this journal was published in March 2017 and then two more issues were published in 2017. In 2018 two issues were published in March and June and now, I am extremely happy to present this third issue (Volume 2, No.3) of JPAC.

The journal aims at publishing inter-disciplinary approaches to global issues related to packaging, environmental aspects, safety aspects, technical and socio-economic challenges related to packaging. In addition, the journal also publishes research articles about the innovative materials developed from natural resources and their application in packaging. Besides, the journal encompasses the application of different types of packaging techniques like Modified Atmosphere Packaging (MAP), Controlled Atmosphere Packaging (CAP), Aseptic Packaging, Retort Packaging etc. and their applications by using various types of processed food products in packaged condition by using different types of packaging materials to enhance the shelf life of processed food products. Apart from packaging techniques and technology, the journal also focuses on the characterization study of different types of composite materials developed from protein based substances, the innovative, attractive package design and its influence on the modern consumer for increasing the sales turn over due to effective and efficient packaging.

The journal also considers research articles on inventory control management of packaging materials, marketing, logistics and supply chain management (SCM) which are also considered as important topics for effective packaging in the modern marketing scenario.

This issue has covered nine important research articles—Optimization of formulation and Process Parameters for Soy Protein-Based Edible Film Using Response Surface Methodology; Characterization and Antimicrobial Property of Casein, Gelatin and Pectin Based Active Composite Films; Eco-friendly Composite Films Based on Polyvinyl Alcohol and Jackfruit Waste Flour; Thermal Processing Characteristics and Storage Studies of Ready-to-Eat Fish-Incorporated Noodles in Semi-Rigid Container; Realizing the End-of-life Considerations in the Design of Food Packaging; Effect of Packaging Material on Colour Kinetics and Biochemical Parameters of Custard Apple Powder During Storage; Study of the Barrier and Mechanical Properties of Packaging Edible Films Fabricated with Hydroxypropyl Methylcellulose (HPMC) Combined with Electro-Activated Whey, PLA/EVA/Teak Wood Flour Biocomposites for Packaging Application: Evaluation of Mechanical Performance and Biodegradation Properties; Effect of Natural Antimicrobials (Clove and Garlic) on Shelf Life and Quality of Mushroom (*Volvariella volvacea*) Under Modified Atmosphere, contributed by the researchers of eminent Universities and Institutions of India and overseas.

It is expected that this journal will be highly useful for the researchers involved in basic as well as applied research in the field of packaging.

I would also like to invite the researchers to submit their papers for double blind peer review. For initial 2 years, the peer reviewed research papers are made available as open access to the world on free of charge for the benefit of researchers as well industry persons. To submit or to read papers, please visit the journal webpage at www.springer.com/41783.

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